

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)			
- 20	0.051 at V _{GS} = - 4.5 V	- 5.1			
	0.067 at V _{GS} = - 3.3 V	- 4.5			
	0.100 at V _{GS} = - 2.5 V	- 3.7			

PWM Optimized **APPLICATIONS**

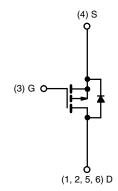
FEATURES

COMPLIANT

- DC/DC
- - HDD
 - Power Supplies

• TrenchFET® Power MOSFET

Portable Devices Such As Cell Phones, PDA, DSC, and DVC



P-Channel MOSFET

TSOP-6 Top View 2.85 mm -

Ordering Information: Si3867DV-T1

Si3867DV-T1-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}\text{C}$, unle	ss otherwise	noted			
Parameter		Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 20		V	
Gate-Source Voltage		V _{GS}	± 12		V	
Ocation - David Ocata (T. 150.00)8	T _A = 25 °C	I _D	- 5.1	- 3.9	•	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 3.7	- 2.8		
Pulsed Drain Current		I _{DM}	- 20		Α	
Continuous Diode Current (Diode Conduction) ^a		I _S	- 1.7	- 0.9		
Maximum Power Dissipation ^a	T _A = 25 °C	- P _D	2.0	1.1	w	
	T _A = 85 °C		1.0	0.6		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manian ma lumation to Ambianta	t ≤ 5 sec	- R _{thJA}	45	62.5	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		90	110		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	25	30		

a. Surface Mounted on 1" x 1" FR4 Board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

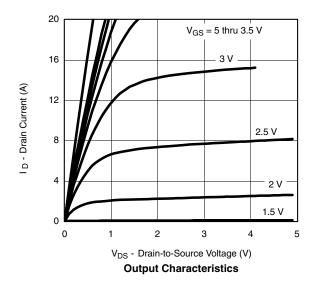
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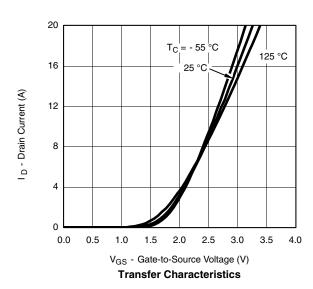


Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static	•			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$ - 0.6		- 1.4	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V		- 1			
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -5.1 \text{ A}$		0.041	0.051	Ω	
		$V_{GS} = -3.3 \text{ V}, I_D = -4.5 \text{ A}$		0.054	0.067		
		$V_{GS} = -2.5 \text{ V}, I_D = -2 \text{ A}$		0.081	0.100		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 5.1 A		11		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.7 A, V _{GS} = 0 V		- 0.7	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			7	11		
Gate-Source Charge	Q_{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 5.1 A		2.3		nC	
Gate-Drain Charge	Q_{gd}			1.6		1	
Turn-On Delay Time	t _{d(on)}			17	30		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		31	50		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, V_{GEN} = - 4.5 V, R_G = 6 Ω		32	50	ns	
Fall Time	t _f			30	50		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.7 A, di/dt = 100 A/μs		25	50		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted





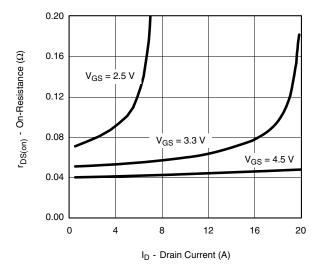
Notes: a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



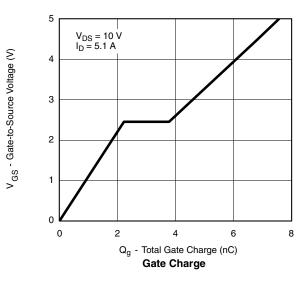




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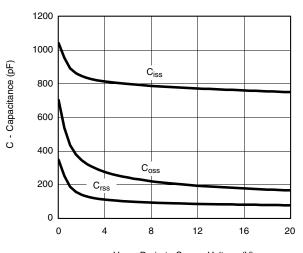
On-Resistance vs. Drain Current



T_J = 25 °C

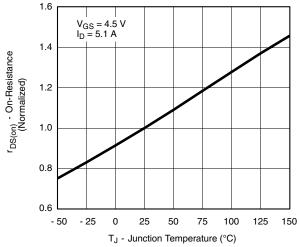
 $T_{J} = 150 \, ^{\circ}C$

 V_{SD} - Source-to-Drain Voltage (V) **Source-Drain Diode Forward Voltage**

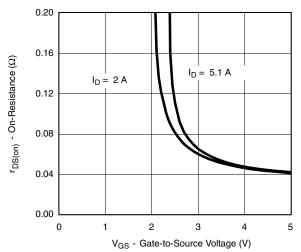


V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

20

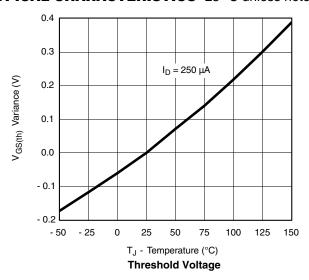
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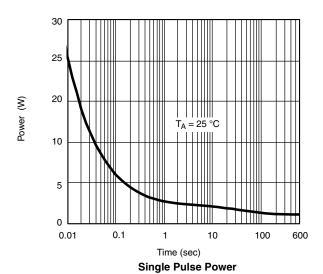
S - Source Current (A)

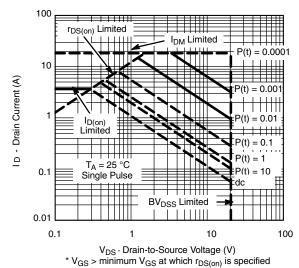
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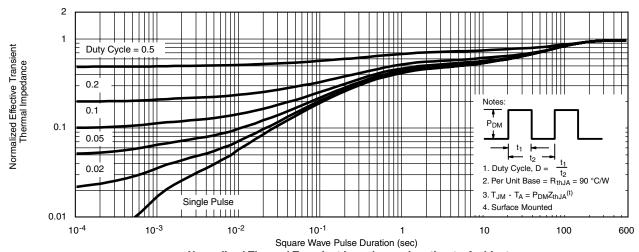
TYPICAL CHARACTERISTICS 25 °C unless noted







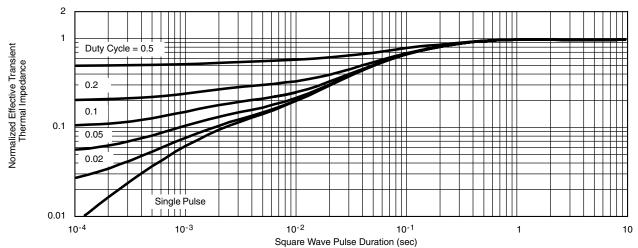




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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